```
16/19/1
012484194
             **Image available**
WPI Acc No: 1999-290302/199925
XRAM Acc No: C99-085930
  Flame retardant resin compositions
Patent Assignee: SHINETSU CHEM CO LTD (SHIE ); SHINETSU CHEM IND CO LTD
  (SHIE )
Inventor: KOBAYASHI Y; YAMAMOTO A; YAMAMOTO K; YAMAYA M
Number of Countries: 027 Number of Patents: 003
Patent Family:
Patent No
              Kind
                     Date
                             Applicat No
                                            Kind
                                                    Date
                                                             Week
EP 918073
               A2 19990526 EP 98309442
                                             Α
                                                  19981118
                                                            199925
JP 11222559
                             JP 98333442
               Α
                   19990817
                                             Α
                                                  19981109
                                                            199943
              A 19990817 JF 90333442
B1 20010206 US 98193851
US 6184312
                                             Α
                                                  19981118 200109
Priority Applications (No Type Date): JP 97335153 A 19971119
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                     Filing Notes
EP 918073
             A2 E 13 C08L-101/00
   Designated States (Regional): AL AT BE CH CY DE DK ES FI FR GB GR IE IT
   LI LT LU LV MC MK NL PT RO SE SI
                  10 C08L-101/00
JP 11222559
            Α
US 6184312
              В1
                       C08G-077/06
Abstract (Basic): EP 918073 A2
        NOVELTY - Small amount of organosiloxane component of specific
    structure, containing phenyl and alkoxy radicals, ensures sufficient
    retardant effect.
        DETAILED DESCRIPTION - The composition comprises
        (A) 100 parts weight synthetic resin with aromatic ring in
    molecule; and
        (B) 0.1-10 parts weight organosiloxane with phenyl and alkoxy
    radicals, of formula (I).
        R1=phenyl;
        R2=1-6C monovalent hydrocarbon radical, excluding phenyl;
        R3=1-4C monovalent hydrocarbon radical;
        m=0.5-2.0;
        n=0-0.9;
        p=0.42-2.5;
        q=0-0.35; and
        m+n+p+q=0.92-2.8.
        INDEPENDENT CLAIMS are also included for:
        (1) flame resistant article made of resin composition as claimed;
    and
        (2) the use of organosiloxane (B) to impart flame retardance to
    organic resin compositions with aromatic rings, especially the ones in
    which the resin is aromatic polycarbonate or aromatic epoxy resin.
        USE - Flame retardant resin compositions are used in production of
    electric and electronic parts, building materials, car parts and
    various daily use goods.
        ADVANTAGE - The composition has good flame retardance, does not
    emit harmful gases on burning, and can be molded into parts having
    optical transparency.
        pp; 13 DwgNo 0/0
Technology Focus:
        TECHNOLOGY FOCUS - ORGANIC CHEMISTRY - Preferred Composition:
    Organosiloxane (B) has preferably weight average molecular weight of
```

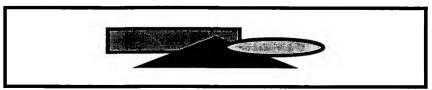
410 up to below 2000, and contains at least 50 mol% of units of formula

(II).

R4=phenyl or 1-6C monovalent hydrocarbon radical, excluding phenyl; and

X=-OH, -OR3 or siloxane residue represented by O1/2, O2/2 and O3/2, when 1, 2 and 3 of X radicals are siloxane residues, respectively, and O atoms bond with other Si atoms to form siloxane bonds, and at least one of the three X radicals attached to one Si atom is a siloxane residue.

POLYMERS - Preferred Components: Component A is preferably aromatic



polycarbonate resin or aromatic epoxy resin.

```
Title Terms: FLAME; RETARD; RESIN; COMPOSITION
Derwent Class: A21; A23; A26; A28; A60; E11
International Patent Class (Main): C08G-077/06; C08L-101/00
International Patent Class (Additional): C08K-005/54; C08L-063/00;
  C08L-069/00; C08L-071/02; C08L-083/04; C08L-083-06; C08L-101/00
File Segment: CPI
Manual Codes (CPI/A-N): A05-A01B; A05-E06A; A06-A00B; A07-A03A; A07-A03B;
 A08-F
Chemical Fragment Codes (M3):
  *01* B514 B712 B720 B741 B742 B760 B794 B831 G010 G019 G100 K930 M121
       M147 M210 M211 M212 M213 M214 M215 M216 M231 M232 M233 M250 M272
       M280 M281 M320 M411 M510 M520 M531 M532 M540 M781 M904 M905 Q130
      Q621 0002-32601-K 0002-32601-U
Polymer Indexing (PS):
  <01>
  *001* 018; D18-R; P0862 P0839 F41 F44 D01 D63; S9999 S1387; M9999 M2073
  *002* 018; ND04; K9745-R; B9999 B4239; N9999 N5970-R; B9999 B4397 B4240;
        K9870 K9847 K9790
  *003* 018; B9999 B5094 B4977 B4740
  *004* 018; A999 A248-R
  *005* 018; A999 A157-R
  <02>
  *001* 018; D18-R; P0464-R D01 D22 D42 F47; S9999 S1387; M9999 M2073
  *002* 018; ND04; K9745-R; B9999 B4239; N9999 N5970-R; B9999 B4397 B4240;
        K9870 K9847 K9790
  *003* 018; A999 A248-R
  *004* 018; A999 A157-R
  <03>
  *001* 018; D11 D10 D19 D18 D76 F86 F87; A999 A248-R; A999 A782; P1445-R
        F81 Si 4A; H0237-R; S9999 S1387
  *002* 018; G2288 G2277 G2266 D01 Si 4A D19 D18 D31 D76 D50 D86 F85 F86 C1
        7A; R01740 G2335 D00 F20 H- O- 6A; A999 A248-R; A999 A782; P1445-R
        F81 Si 4A; H0011-R; L9999 L2528 L2506; H0237-R; M9999 M2391
  *003* 018; B9999 B5094 B4977 B4740; N9999 N6177-R; N9999 N5709; N9999
        N6735-R N6655; K9949
  *004* 018; R00270 D01 D11 D10 D50 D81 F27 F26; C999 C204; C999 C306
  *005* 018; R00862 D01 D02 D11 D10 D19 D18 D31 D50 D76 D87; A999 A475
  *001* 018; A999 A157-R; A999 A782; P0226 P0282-R D01 D18 F30
Generic Compound Numbers: 0002-32601-K; 0002-32601-U
```

Key Word Indexing Terms:
 01 0002-32601-CL, USE